

#### **Description**

The VSM25P14 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

#### **General Features**

V<sub>DS</sub> =-150V,I<sub>D</sub> =-25A

 $R_{DS(ON)}$  <135m $\Omega$  @  $V_{GS}$ =-10V (Typ.=120mR)

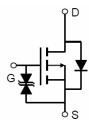
 $R_{DS(ON)}$  <160m $\Omega$  @  $V_{GS}$ =-4.5V (Typ.=131mR)

- Super high dense cell design
- Advanced trench process technology
- Reliable and rugged
- High density cell design for ultra low On-Resistance

### **Application**

Portable equipment and battery powered systems





Schematic Diagram

**Package Marking and Ordering Information** 

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VSM25P14-T1	VSM25P14	TO-251	-	-	-

### Absolute Maximum Ratings (T<sub>C</sub>=25 ℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	-150	V	
Gate-Source Voltage	V <sub>G</sub> s	±20	V	
Drain Current-Continuous	I <sub>D</sub>	-25	А	
Drain Current-Continuous(T <sub>C</sub> =100 ℃)	I <sub>D</sub> (100℃)	-17	А	
Pulsed Drain Current	I <sub>DM</sub>	-140	А	
Maximum Power Dissipation	P <sub>D</sub>	160	W	
Derating factor		1.3	W/°C	
Operating Junction and Storage Temperature Range	$T_{J}$ , $T_{STG}$	T <sub>J</sub> ,T <sub>STG</sub> -55 To 150		



Shenzhen VSEEI Semiconductor Co., Ltd

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case (Note 2)	R <sub>θJc</sub>	0.8	°C/W	1
---	------------------	-----	------	---

## Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

Symbol	Condition	Min	Тур	Max	Unit	
		•				
BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-145	-155	-	V	
I <sub>DSS</sub>	V <sub>DS</sub> =-145V,V <sub>GS</sub> =0V	-	-	1	μA	
I <sub>GSS</sub>	$V_{GS}$ =±20 $V$ , $V_{DS}$ =0 $V$	-	-	±10	μA	
		•				
$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_{D}=-250\mu A$	-1.5	-1.9	-3	V	
R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-20A	-	120	135	mO.	
	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-20A	- 131 16		160	mΩ	
<b>g</b> FS	V <sub>DS</sub> =-5V,I <sub>D</sub> =-20A	5	-	-	S	
		•				
C <sub>lss</sub>	75/// 0//	-	7650	-	PF	
C <sub>oss</sub>		-	148	-	PF	
C <sub>rss</sub>	F-1.UIVIDZ	-	131	-	PF	
		•				
t <sub>d(on)</sub>		-	17	-	nS	
t <sub>r</sub>	$V_{DD}$ =-75 $V$ , $I_{D}$ =-20 $A$	-	80	-	nS	
t <sub>d(off)</sub>	$V_{GS}$ =-10 $V$ , $R_{GEN}$ =9.1 $\Omega$	-	45	-	nS	
t <sub>f</sub>		-	65	-	nS	
Qg	\/ - 75\/   - 204	-	137	-	nC	
Q <sub>gs</sub>		-	25	-	nC	
Q <sub>gd</sub>	V <sub>GS</sub> =-10V	-	28	-	nC	
		•				
V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-25A	-	-	-1.2	V	
Is	-	-	-	-25	Α	
t <sub>rr</sub>	TJ = 25°C, IF =-25A	-	90	-	nS	
Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	105	-	nC	
	BVDSS   IDSS   IDSS	BV <sub>DSS</sub>	BV <sub>DSS</sub>	BV <sub>DSS</sub>	BVDSS	

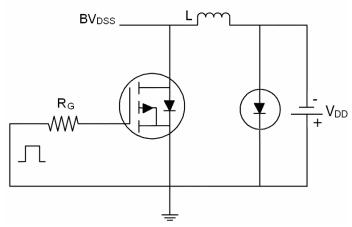
#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width ≤  $300\mu$ s, Duty Cycle ≤ 2%.
- **4.** Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25  $^{\circ}\text{C}$  ,VDD=-75V,VG=-10V,L=0.5mH,Rg=25 $\Omega$

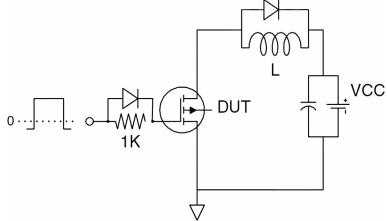


### **Test Circuit**

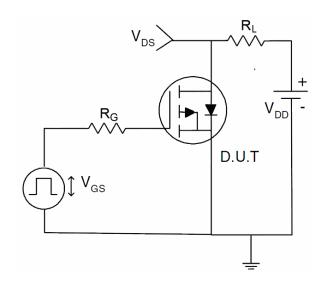
# 1) E<sub>AS</sub> Test Circuit



## 2) Gate Charge Test Circuit

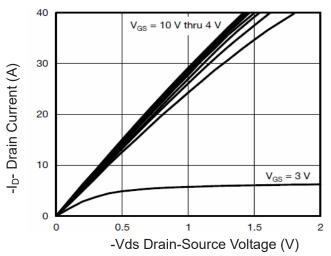


## 3) Switch Time Test Circuit

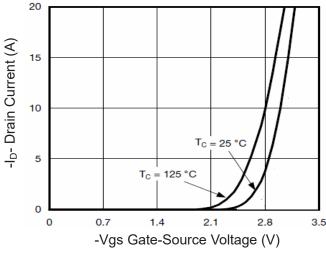




### **Typical Electrical and Thermal Characteristics (Curves)**



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

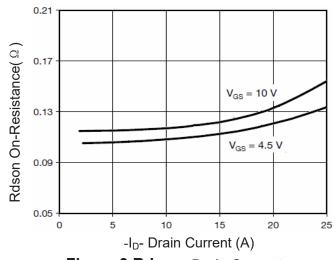


Figure 3 Rdson- Drain Current

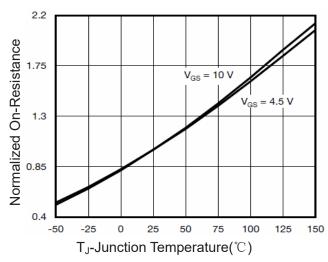


Figure 4 Rdson-JunctionTemperature

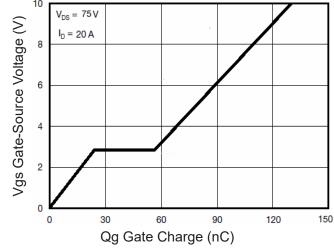


Figure 5 Gate Charge

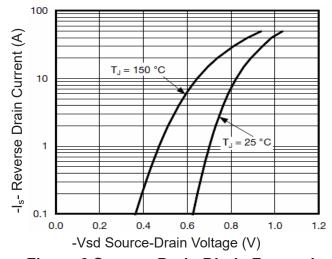
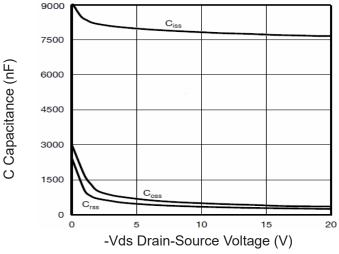


Figure 6 Source- Drain Diode Forward

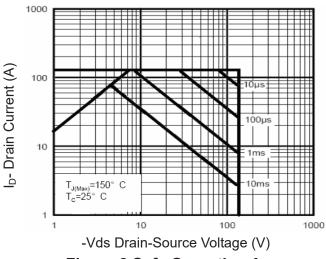




(V) tuend 20 20 10 0 25 50 75 100 125 150 175 T<sub>C</sub> Case Temperature(°C)

Figure 7 Capacitance vs Vds

Figure 9 Drain Current vs Case Temperature



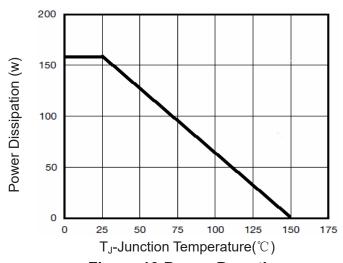
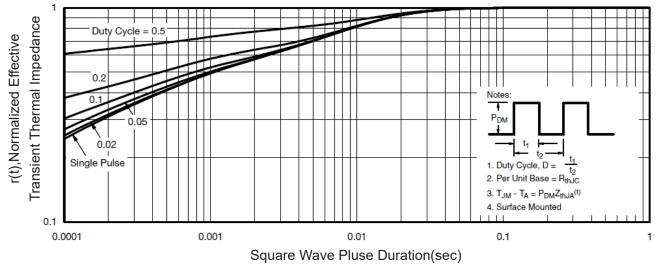


Figure 8 Safe Operation Area

Figure 10 Power De-rating



**Figure 11 Normalized Maximum Transient Thermal Impedance**